# SY89855U

Precision Low Power Differential LVPECL 4:1 MUX with 1:2 Fanout and Internal Termination

### **General Description**

The SY89855U is a 2.5V/3.3V precision, high-speed, 4:1 differential multiplexer with 100K LVPECL (800mV) compatible outputs, capable of handling clocks up to 2.5GHz and data streams up to 2.5Gbps. In addition, a 1:2 fanout buffer provides two copies of the selected inputs.

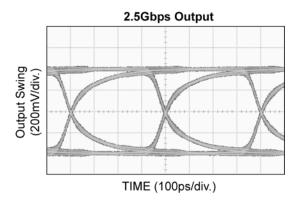
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The differential input includes Micrel's unique, 3-pin input termination architecture that allows customers to interface to any differential signal (AC- or DC-coupled) as small as 100mV without any level shifting or termination resistor networks in the signal path. The result is a clean, stub-free, low-jitter interface solution. The outputs are 800mV LVPECL, (100K temperature compensated) with fast rise/fall times guaranteed to be less than 180ps.

The SY89855U operates from a 2.5V  $\pm$ 5% supply or a 3.3V  $\pm$ 10% supply and is guaranteed over the full industrial temperature range of -40°C to +85°C. For applications that require higher performance, consider the SY58029U. The SY89855U is part of Micrel's high-speed, Precision Edge<sup>®</sup> product line.

All support documentation can be found on Micrel's web site at <u>www.micrel.com</u>.

## **Typical Performance**



United States Patent No. RE44,134 Precision Edge is a registered trademark of Micrel, Inc.

Micrel Inc. • 2180 Fortune Drive • San Jose, CA 95131 • USA • tel +1 (408) 944-0800 • fax + 1 (408) 474-1000 • http://www.micrel.com

Features

- Select 1 of 4 differential inputs
- · Provides two copies of the selected input
- Low power 260mW ( $V_{CC}$  = 2.5V)
- Guaranteed AC performance over temperature and voltage:

Precision Edge

- DC-to->2.5Gbps data rate throughput
- <410ps In-to-Q t<sub>pd</sub>
- <180ps t<sub>r</sub> / t<sub>f</sub> times
- Ultra low-jitter design:
  - <10ps<sub>PP</sub> total jitter (clock)
  - <1ps<sub>RMS</sub> random jitter
  - <10ps<sub>PP</sub> deterministic jitter
  - <0.7ps<sub>RMS</sub> crosstalk-induced jitter
- Unique, patent-pending input design minimizes crosstalk
- Accepts an input signal as low as 100mV
- Unique patented input termination and VT pin accepts DC- and AC-coupled inputs (CML, LVPECL, LVDS)
- 800mV 100K LVPECL output swing
- Power supply 2.5V ±5% or 3.3V ±10%
- –40°C to +85°C temperature range
- Available in 32-pin (5mm x 5mm) QFN package

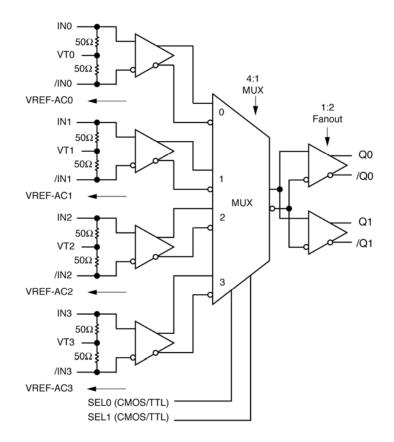
#### **Applications**

- Redundant clock and/or data distribution
- All SONET/OC-3 to OC-48 clock/data distribution
- Loopback
- All Fibre Channel applications
- All GigE applications

#### Markets

- LAN/WAN communication
- Enterprise servers
- ATE
- Test and measurement

## **Functional Block Diagram**



## **Truth Table**

| SEL1 | SEL0 | Q                |
|------|------|------------------|
| 0    | 0    | IN0 Input Select |
| 0    | 1    | IN1 Input Select |
| 1    | 0    | IN2 Input Select |
| 1    | 1    | IN3 Input Select |

## Ordering Information<sup>(1)</sup>

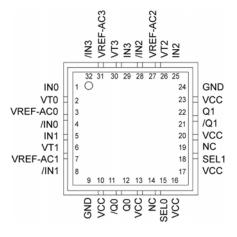
| Part Number                 | Package<br>Type | Operating<br>Range | Package Marking                          | Lead Finish    |
|-----------------------------|-----------------|--------------------|--|----------------|
| SY89855UMG                  | QFN-32          | Industrial         | SY89855U with Pb-Free bar-line indicator | NiPdAu Pb-Free |
| SY89855UMGTR <sup>(2)</sup> | QFN-32          | Industrial         | SY89855U with Pb-Free bar-line indicator | NiPdAu Pb-Free |

#### Notes:

1. Contact factory for die availability. Dice are guaranteed at  $T_A$  = 25°C, DC Electricals only.

2. Tape and Reel.

## **Pin Configuration**



32-Pin QFN

#### **Pin Description**

| Pin Number                       | Pin Name  | Pin Function   |  |
|----------------------------------|---|--|--|
| 1, 4<br>5, 8<br>25, 28<br>29, 32 | IN0, /IN0,<br>IN1, /IN1,<br>IN2, /IN2,<br>IN3, /IN3 | Differential Input: Each pair accepts AC- or DC-coupled signals as small as 100mV. Each pin of a pair internally terminates to a VT pin through 50 $\Omega$ . Note that these inputs will default to an indeterminate state if left open. If an input is not used, connect one end of the differential pairs to ground through a 1k $\Omega$ resistor, and leave the other end to VCC through an 825 $\Omega$ resistor. Unused VT and VREF-AC pins may also be left floating. Please refer to the "Input Interface Applications" section for more details. |  |
| 2, 6<br>26, 30                   | VT0, VT1<br>VT2, VT3                                | put Termination Center-Tap: Each side of the differential input pair terminates to a VT<br>in. The VT pin provides a center-tap to the termination network for maximum interface<br>exibility. See "Input Interface Applications" section for more details.  |  |
| 15, 18                           | SEL0, SEL1  | This Single-Ended TTL/CMOS compatible input selects the inputs to the multiplexer. No that this input is internally connected to a $25k\Omega$ pull-up resistor and will default to a logic HIGH state if left open. Input logic threshold is V <sub>CC</sub> /2. See "Truth Table" for select control   |  |
| 14, 19                           | NC  | Not connected.   |  |
| 10, 13, 16<br>17, 20, 23         | VCC   | Positive Power Supply: Bypass with $0.1\mu$ F   $0.01\mu$ F low ESR capacitors placed as close as possible to each VCC pin.  |  |
| 11, 12<br>21, 22                 | /Q0, Q0<br>/Q1, Q1                                  | Differential Outputs: These 100K-compatible (internally temperature compensated) LVPECL output pairs are copies of the selected input. Unused output pins may be left floating. See "Output Interface" for terminating guidelines.   |  |
| 9, 24                            | GND,<br>Exposed Pad                                 | Ground: Ground pins and exposed pad must be connected to the most negative potential of the chip.  |  |
| 3<br>7<br>27<br>31               | VREF-AC0,<br>VREF-AC1,<br>VREF-AC2,<br>VREF-AC3     | Reference Voltage: This reference output is equivalent to V <sub>CC</sub> -1.2V. It is used for AC-<br>coupled inputs. When interfacing to AC input signals, connect VREF-AC directly to the VT<br>pin and bypass with a 0.01 $\mu$ F low ESR capacitor to VCC. See "Input Interface<br>Applications" section. Maximum sink/source current is ± 1.5mA.   |  |

#### Absolute Maximum Ratings<sup>(1)</sup>

| Supply Voltage ( $V_{CC}$ )0.5V to +4.0V<br>Input Voltage ( $V_{IN}$ )0.5V to $V_{CC}$ |
|--|
| LVPECL Output Current (I <sub>OUT</sub> )  |
| Continuous ±50mA   |
| Surge ±100mA   |
| Termination Current  |
| Source or Sink Current on V <sub>T</sub> ±100mA  |
| Input Current  |
| Source or Sink Current on IN, /IN ±50mA  |
| Current (V <sub>REF-AC</sub> )   |
| Source or Sink Current on V <sub>REF-AC</sub> ±2mA                                     |
| Lead Temperature (soldering, 20sec.)   |
| Storage Temperature (T <sub>s</sub> )  |
|  |

### **Operating Ratings**<sup>(2)</sup>

| Supply Voltage (V <sub>CC</sub> )         |        |
|---|--------|
| Ambient Temperature (T₄)                  |        |
| Package Thermal Resistance <sup>(3)</sup> |        |
| $QFN(\theta_{JA})$                        |        |
| Still-Air                                 | 35°C/W |
| 500lfpm                                   | 28°C/W |
| QFN (Ψ <sub>JB</sub> )                    |        |
| Junction-to-Board                         | 16°C/W |

#### DC Electrical Characteristics<sup>(4)</sup>

 $T_A = -40^{\circ}C$  to +85°C, unless otherwise noted.

| Symbol                 | Parameter  | Condition  | Min                   | Тур                   | Max                   | Units  |
|------------------------|--|--|-----------------------|-----------------------|-----------------------|--------|
| Vcc                    | Power Supply Voltage   | V <sub>CC</sub> = 2.5V<br>V <sub>CC</sub> = 3.3V | 2.375<br>3.0          | 2.5<br>3.3            | 2.625<br>3.6          | V<br>V |
| I <sub>CC</sub>        | Power Supply Current   | No load, max. V <sub>CC</sub> .                  |                       | 65                    | 85                    | mA     |
| R <sub>IN</sub>        | Input Resistance<br>(IN-to-VT)                                       |  | 45                    | 50                    | 55                    | Ω      |
| $R_{\text{DIFF}_{IN}}$ | Differential Input Resistance<br>(IN-to-/IN, /IN-to-V <sub>T</sub> ) |  | 90                    | 100                   | 110                   | Ω      |
| VIH                    | Input High Voltage<br>(IN, /IN)                                      | Note 5   | V <sub>CC</sub> - 1.6 |                       | Vcc                   | V      |
| V <sub>IL</sub>        | Input Low Voltage<br>(IN, /IN)                                       |  | 0                     |                       | V <sub>IH</sub> - 0.1 | V      |
| V <sub>IN</sub>        | Input Voltage Swing<br>(IN-to-/IN)                                   | See Figure 1a.                                   | 0.1                   |                       | 1.7                   | V      |
| $V_{DIFF\_IN}$         | Differential Input Voltage Swing                                     | See Figure 1b.                                   | 0.2                   |                       |                       | V      |
| $V_{T\_IN}$            | Maximum Input Voltage<br>(IN-to-V⊤)                                  |  |                       |                       | 1.28                  | V      |
| V <sub>REF-AC</sub>    | Output Reference Voltage   |  | V <sub>CC</sub> - 1.3 | V <sub>CC</sub> - 1.2 | V <sub>CC</sub> - 1.1 | V      |

Notes:

 Permanent device damage may occur if absolute maximum ratings are exceeded. This is a stress rating only and functional operation is not implied at conditions other than those detailed in the operational sections of this data sheet. Exposure to absolute maximum ratings conditions for extended periods may affect device reliability.

2. The data sheet limits are not guaranteed if the device is operated beyond the operating ratings.

Package thermal resistance assumes exposed pad is soldered (or equivalent) to the devices most negative potential on the PCB. θ<sub>JA</sub> and ψ<sub>JB</sub> values are determined for a 4-layer board in still-air, unless otherwise stated.

4. The circuit is designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.

5.  $V_{IH}$  (min) not lower than 1.2V.

# LVPECL Output DC Electrical Characteristics<sup>(5)</sup>

 $V_{CC}$  = 2.5V ±5% or 3.3V ±10%;  $R_L$  = 50 $\Omega$  to  $V_{CC}$ -2V;  $T_A$  = -40°C to +85°C, unless otherwise noted.

| Symbol                | Parameter                                 | Condition      | Min                    | Тур  | Max                    | Units |
|-----------------------|---|----------------|------------------------|------|------------------------|-------|
| V <sub>OH</sub>       | Output High Voltage<br>(Q, /Q)            |                | V <sub>CC</sub> -1.145 |      | V <sub>CC</sub> -0.895 | V     |
| V <sub>OL</sub>       | Output Low Voltage<br>(Q, /Q)             |                | V <sub>CC</sub> -1.945 |      | V <sub>CC</sub> -1.695 | V     |
| V <sub>OUT</sub>      | Output Voltage Swing<br>(Q, /Q)           | See Figure 1a. | 400                    | 800  |                        | mV    |
| V <sub>DIFF-OUT</sub> | Differential Output Voltage Swing (Q, /Q) | See Figure 1b. | 800                    | 1600 |                        | mV    |

## LVTTL/CMOS DC Electrical Characteristics<sup>(5)</sup>

 $V_{CC}$  = 2.5V ±5% or 3.3V ±10%;  $T_A$  = -40°C to +85°C, unless otherwise noted.

| Symbol          | Parameter          | Condition              | Min  | Тур | Max | Units |
|-----------------|--------------------|------------------------|------|-----|-----|-------|
| VIH             | Input High Voltage |                        | 2.0  |     |     | V     |
| VIL             | Input Low Voltage  |                        |      |     | 0.8 | V     |
| I <sub>IH</sub> | Input High Current | $V_{IN} = V_{CC}$      |      |     | 75  | μA    |
| IIL             | Input Low Current  | V <sub>IN</sub> = 0.5V | -300 |     |     | μA    |

Notes:

5. The circuit is designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.

## AC Electrical Characteristics<sup>(6)</sup>

 $V_{CC}$  = 2.5V ±5% or 3.3V ±10%;  $T_A$  = –40°C to + 85°C,  $R_L$  = 50 $\Omega$  to  $V_{CC}$ –2V, unless otherwise stated.

| Symbol                         | Parameter   | Condition                       | Min | Тур | Max | Units                    |
|--------------------------------|---|---------------------------------|-----|-----|-----|--------------------------|
| f <sub>MAX</sub>               | Maximum Operating Frequency                               | NRZ Data                        | 2.5 |     |     | Gbps                     |
|                                |   | Clock, V <sub>OUT</sub> > 400mV | 2.5 |     |     | GHz                      |
| t <sub>pd</sub>                | Propagation Delay   |                                 |     |     |     |                          |
|                                | IN-to-Q   | V <sub>IN</sub> > 100mV         | 210 | 300 | 410 | ps                       |
|                                | SEL-to-Q  |                                 | 100 | 300 | 500 | ps                       |
| t <sub>pd</sub><br>Tempco      | Differential Propagation Delay<br>Temperature Coefficient |                                 |     | 234 |     | fs/°C                    |
| t <sub>SKEW</sub>              | Output-to-Output  | Note 7                          |     | 9   | 20  | ps                       |
|                                | Part-to-Part  | Note 8                          |     |     | 150 | ps                       |
| t <sub>JITTER</sub>            | Data  |                                 |     |     |     |                          |
|                                | Random Jitter (RJ)  | Note 9                          |     |     | 1   | ps <sub>RMS</sub>        |
|                                | Deterministic Jitter (DJ)                                 | Note 10                         |     |     | 10  | ps <sub>PP</sub>         |
|                                | Clock   |                                 |     |     |     |                          |
|                                | Cycle-to-Cycle Jitter                                     | Note 11                         |     |     | 1   | <b>ps</b> <sub>RMS</sub> |
|                                | Total Jitter (TJ)   | Note 12                         |     |     | 10  | ps <sub>PP</sub>         |
|                                | Crosstalk-induced Jitter<br>(Adjacent Channel)            | Note 13                         |     |     | 0.7 | ps <sub>RMS</sub>        |
| t <sub>r,</sub> t <sub>f</sub> | Output Rise/Fall Time (20% to 80%)                        | At full output swing.           | 50  | 100 | 180 | ps                       |

Notes:

6. High frequency AC electricals are guaranteed by design and characterization.

7. Output-to-output skew is measured between outputs under identical input conditions.

8. Part-to-part skew is defined for two parts with identical power supply voltages at the same temperature and with no skew of the edges at the respective inputs.

9. Random jitter is measured with a K28.7 character pattern, measured at <f<sub>MAX</sub>.

10. Deterministic jitter is measured at 2.5Gbps with both K28.5 and 2<sup>23</sup>-1 PRBS pattern.

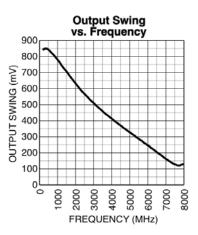
11. Cycle-to-cycle jitter definition: the variation of periods between adjacent cycles, T<sub>n</sub> – T<sub>n-1</sub> where T is the time between rising edges of the output signal.

12. Total jitter definition: with an ideal clock input of frequency <f<sub>MAX</sub>, no more than one output edge in 10<sup>12</sup> output edges will deviate by more than the specified peak-to-peak jitter value.

13. Crosstalk is measured at the output while applying two similar differential clock frequencies that are asynchronous with respect to each other at the inputs.

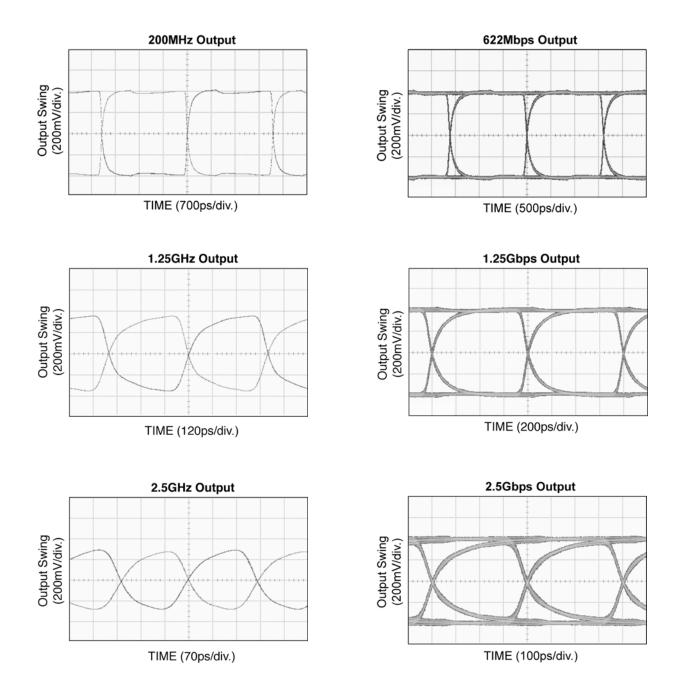
## **Typical Operating Characteristics**

 $V_{CC}$  = 2.5V, GND = 0,  $V_{IN}$  = 100mV;  $T_A$  = -40°C to + 85°C,  $R_L$  = 50 $\Omega$  to  $V_{CC}$ -2V, unless otherwise stated.

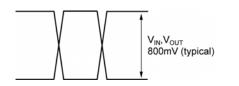


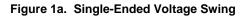
# **Functional Characteristics**

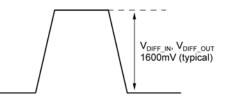
 $V_{CC}$  = 3.3V ±10%;  $T_A$  = –40°C to + 85°C,  $R_L$  = 50 $\Omega$  to  $V_{CC}$  –2V, unless otherwise stated.



### **Single-Ended and Differential Swings**

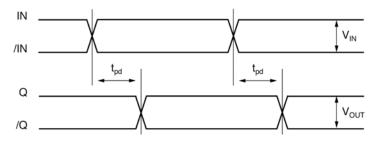




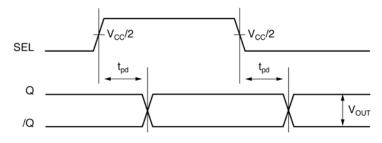




### **Timing Diagram**



**IN-to-Q Timing Diagram** 



SEL-to-Q Timing Diagram

#### **Input and Output Stages**

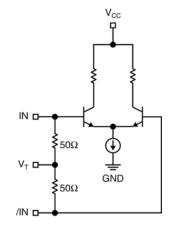


Figure 2a. Simplified Differential Input Stage

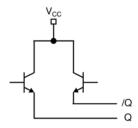
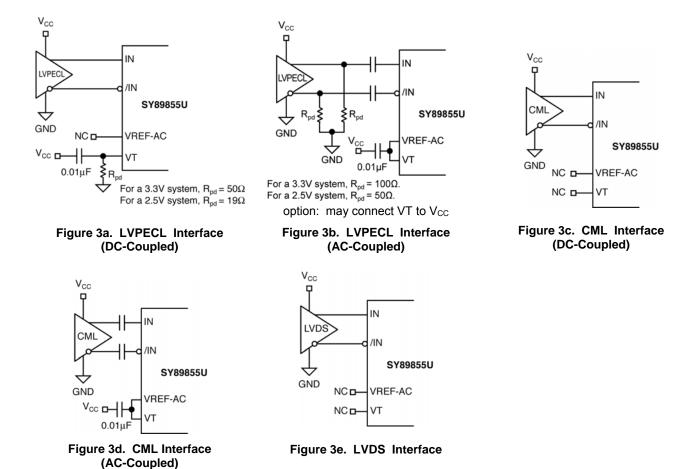


Figure 2b. PECL Output Stage

## **Input Interface Applications**

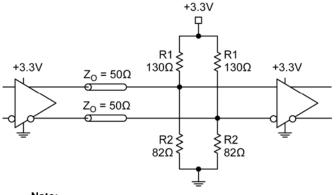


Note:

#### **Output Interface Applications**

LVPECL has high input impedance, very low output (open emitter) impedance, and small signal swing, which result in low EMI. LVPECL is ideal for driving  $50\Omega$  and  $100\Omega$  controlled impedance transmission lines. There are different techniques for terminating

LVPECL outputs: parallel termination theveninequivalent, parallel termination (3-resistor), and ACcoupled termination. Unused output pairs may be left floating; however, single-ended outputs must be terminated or balanced.



Note:

For a 2.5V system, R1 =  $250\Omega$ , R2 =  $62.5\Omega$ .

+3.3V

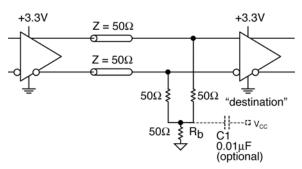
100Ω

For a 2.5V system,  $R = 50\Omega$ .

#### Figure 4a. Parallel Thevenin-Equivalent Termination

0.1µF

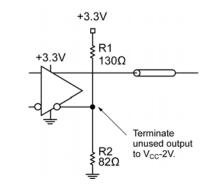
0.1µF



Note:

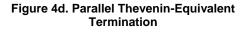
1. For a 2.5V system, Rb =  $19\Omega$ .

Figure 4b. Parallel Termination (3-Resistor)



Note:

For a 2.5V system, R1 = 250 $\Omega$ , R2 = 62.5  $\Omega$ .



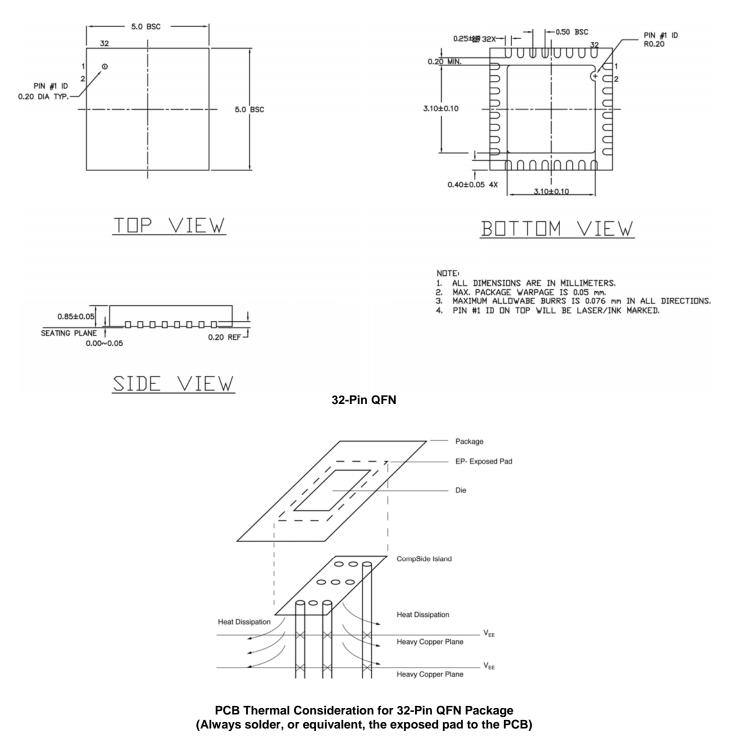
#### **Related Product and Support Documentation**

R 100Ω

Figure 4c. AC-Coupled Termination

| Part Number   | Function  | Data Sheet Link                                      |
|---------------|---|--|
| SY58029U      | Ultra Precision Differential LVPECL 4 :1<br>MUX with 1 :2 Fanout Internal Termination | www.micrel.com/product-info/products/sy58029u.shtml. |
| HBW Solutions | New Products and Applications   | www.micrel.com/product-info/products/solutions.shtml |

## **Package Information**



#### Packages Notes:

- 1. Package meets Level 2 Moisture Sensitivity Classification.
- 2. All parts are dry-packed before shipment.
- 3. Exposed pads must be soldered to a ground for proper thermal management.

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